

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Appl. for Reissue No. : 09/714,680  
Patent No. : 6,054,198  
Applicant : Bunyan *et al.*  
Filed : November 16, 2000  
Title : Conformal Thermal Interface  
Material For Electronic Components  
  
TC/A.U. : 1773  
Examiner : D. L. Tarazano  
  
Docket No. : 2802-257-006

Honorable Commissioner For Patents  
Alexandria, VA 22313-1450

**AMENDMENT**

In response to the Office action of December 01, 2006, reconsideration of the identified application is respectfully requested:

**Remarks** begin on page 2 of this paper.